Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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ALPHA & OMEGA SEMICONDUCTOR

AOB15B60D

600V, 15A Alpha IGBT™ with Diode

General Description

The Alpha IGBT™ line of products offers best-in-class performance in conduction and switching losses, with robust short circuit capability. They are designed for ease of paralleling, minimal gate spike under high dV/dt conditions and resistance to oscillations. The soft co-package diode is targeted for minimal losses in motor control applications.

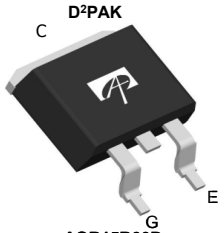
Product Summary

V_{CE}	600V
I_C (T_C=100°C)	15A
$V_{CE(sat)}$ (T_C=25°C)	1.6V

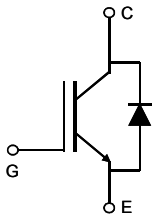
RoHS Compliant

Top View

TO-263
D²PAK



AOB15B60D



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	AOB15B60D	Units
Collector-Emitter Voltage		V_{CE}	600	V
Gate-Emitter Voltage		V_{GE}	±20	V
Continuous Collector Current	T_C=25°C	I_C	30	A
	T_C=100°C		15	
Pulsed Collector Current, Limited by T_{Jmax}		I_{CM}	60	A
Turn off SOA, V_{CE} ⩽ 600V, Limited by T_{Jmax}		I_{LM}	60	A
Continuous Diode Forward Current	T_C=25°C	I_F	30	A
	T_C=100°C		15	
Diode Pulsed Current, Limited by T_{Jmax}		I_{FM}	60	A
Short circuit withstanding time V_{GE} = 15V, V_{CE} ⩽ 400V, Delay between short circuits ⩾ 1.0s, T_C=25°C		t_{SC}	10	µs
Power Dissipation	T_C=25°C	P_D	167	W
	T_C=100°C		83.3	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		T_L	300	°C

Thermal Characteristics

Parameter	Symbol	AOB15B60D	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	65	°C/W
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	0.9	°C/W
Maximum Diode Junction-to-Case	$R_{\theta JC}$	1.5	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ	Max	Units
STATIC PARAMETERS							
BV_{CES}	Collector-Emitter Breakdown Voltage	I_C=250µA, V_{GE}=0V, T_J=25°C		600	-	-	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	V_{GE}=15V, I_C=15A	T_J=25°C	-	1.6	1.8	V
			T_J=125°C	-	1.85	-	
			T_J=150°C	-	1.92	-	
V_F	Diode Forward Voltage	V_{GE}=0V, I_C=15A	T_J=25°C	-	1.43	1.72	V
			T_J=125°C	-	1.39	-	
			T_J=150°C	-	1.36	-	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	V_{CE}=V_{GE}, I_C=250µA		-	5.6	-	V
I_{CES}	Zero Gate Voltage Collector Current	V_{CE}=600V, V_{GE}=0V	T_J=25°C	-	-	10	µA
			T_J=125°C	-	-	300	
			T_J=150°C	-	-	1500	
I_{GES}	Gate-Emitter leakage current	V_{CE}=0V, V_{GE}=±20V		-	-	±100	nA
g_{FS}	Forward Transconductance	V_{CE}=20V, I_C=15A		-	7.7	-	S
DYNAMIC PARAMETERS							
C_{ies}	Input Capacitance	V_{GE}=0V, V_{CE}=25V, f=1MHz		-	1290	-	pF
C_{oes}	Output Capacitance			-	97	-	pF
C_{res}	Reverse Transfer Capacitance			-	3.1	-	pF
Q_g	Total Gate Charge	V_{GE}=15V, V_{CE}=480V, I_C=15A		-	25.4	-	nC
Q_{ge}	Gate to Emitter Charge			-	9.5	-	nC
Q_{gc}	Gate to Collector Charge			-	8.3	-	nC
$I_{C(SC)}$	Short circuit collector current, Max. 1000 short circuits, Delay between short circuits ⩾ 1.0s	V_{GE}=15V, V_{CE}=400V, R_G=20Ω		-	74	-	A
R_g	Gate resistance	V_{GE}=0V, V_{CE}=0V, f=1MHz		-	2.4	-	Ω
SWITCHING PARAMETERS, (Load Iductive, T_J=25°C)							
$t_{D(on)}$	Turn-On DelayTime	T_J=25°C V_{GE}=15V, V_{CE}=400V, I_C=15A, R_G=20Ω, Parasitic Inductance=100nH		-	21	-	ns
t_r	Turn-On Rise Time			-	19	-	ns
$t_{D(off)}$	Turn-Off Delay Time			-	73	-	ns
t_f	Turn-Off Fall Time			-	10	-	ns
E_{on}	Turn-On Energy			-	0.42	-	mJ
E_{off}	Turn-Off Energy			-	0.11	-	mJ
E_{total}	Total Switching Energy			-	0.53	-	mJ
t_{rr}	Diode Reverse Recovery Time	T_J=25°C I_F=15A,dI/dt=200A/µs,V_{CE}=400V		-	196	-	ns
Q_{rr}	Diode Reverse Recovery Charge			-	0.48	-	µC
I_{rm}	Diode Peak Reverse Recovery Current			-	5.8	-	A
SWITCHING PARAMETERS, (Load Iductive, T_J=150°C)							
$t_{D(on)}$	Turn-On DelayTime	T_J=150°C V_{GE}=15V, V_{CE}=400V, I_C=15A, R_G=20Ω, Parasitic Inductance=100nH		-	21	-	ns
t_r	Turn-On Rise Time			-	19	-	ns
$t_{D(off)}$	Turn-Off Delay Time			-	91	-	ns
t_f	Turn-Off Fall Time			-	8	-	ns
E_{on}	Turn-On Energy			-	0.54	-	mJ
E_{off}	Turn-Off Energy			-	0.19	-	mJ
E_{total}	Total Switching Energy			-	0.73	-	mJ
t_{rr}	Diode Reverse Recovery Time	T_J=150°C I_F=15A,dI/dt=200A/µs,V_{CE}=400V		-	235	-	ns
Q_{rr}	Diode Reverse Recovery Charge			-	1.1	-	µC
I_{rm}	Diode Peak Reverse Recovery Current			-	8.5	-	A

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

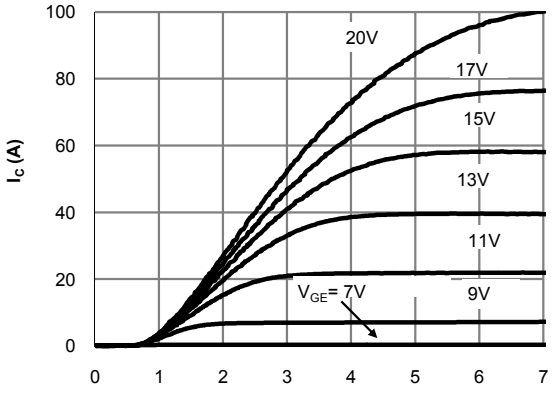


Fig 1: Output Characteristic (T_j=25°C)

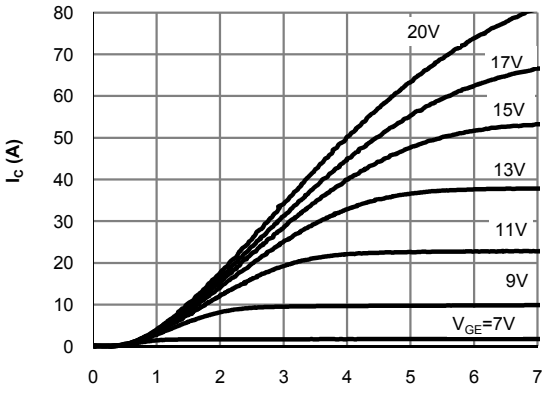


Fig 2: Output Characteristic (T_j=150°C)

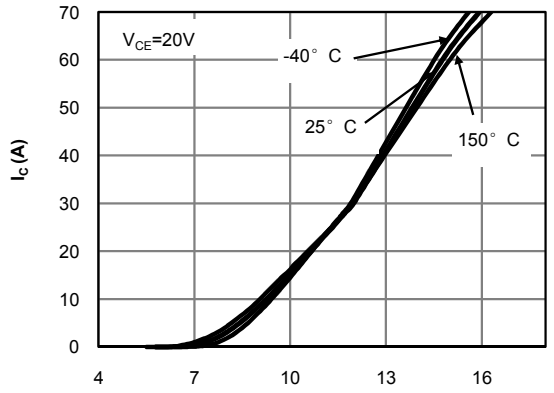


Fig 3: Transfer Characteristic

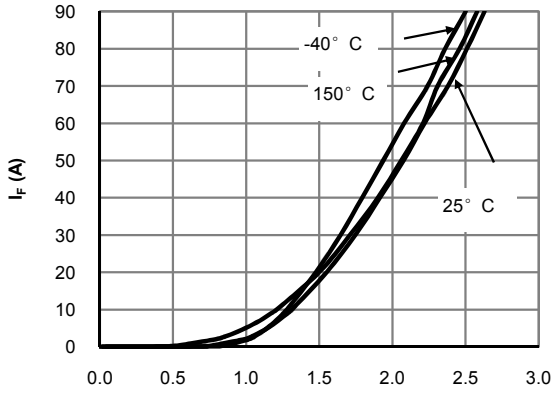


Fig 4: Diode Characteristic

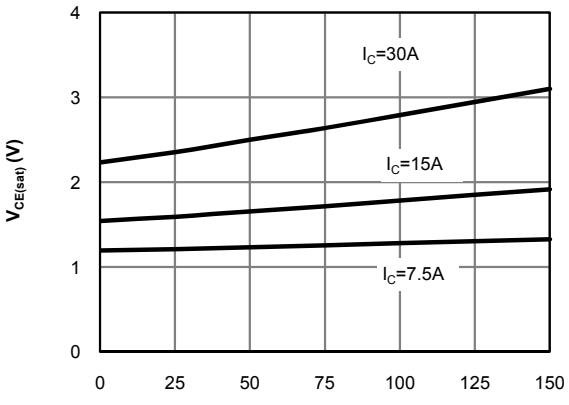


Fig 5: Collector-Emitter Saturation Voltage vs. Junction Temperature

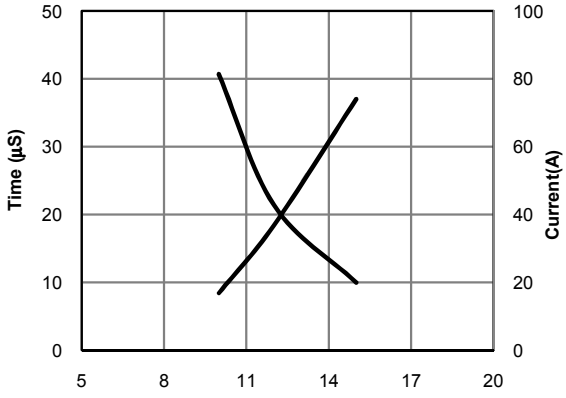


Fig 6: V_{GE} vs. Short Circuit Time (V_{CE}=400V,T_C=25°C)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

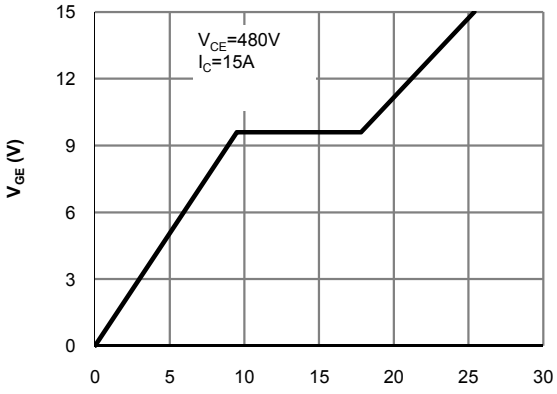


Fig 7: Gate-Charge Characteristics

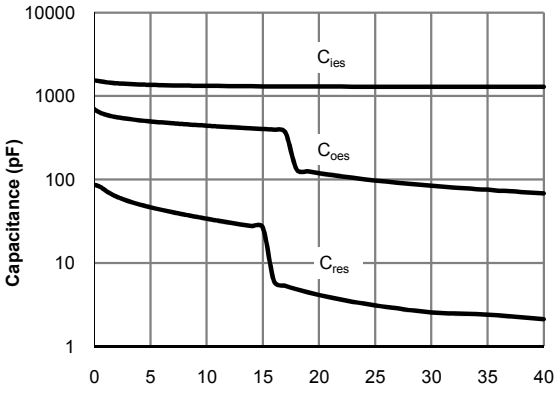


Fig 8: Capacitance Characteristic

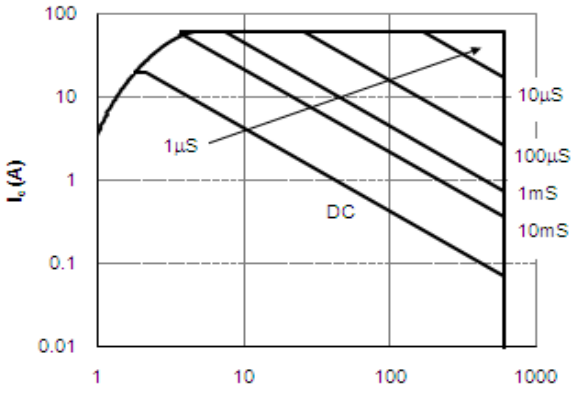


Fig 9: Forward Bias Safe Operating Area
(T_C=25C,V_{GE}=15V)

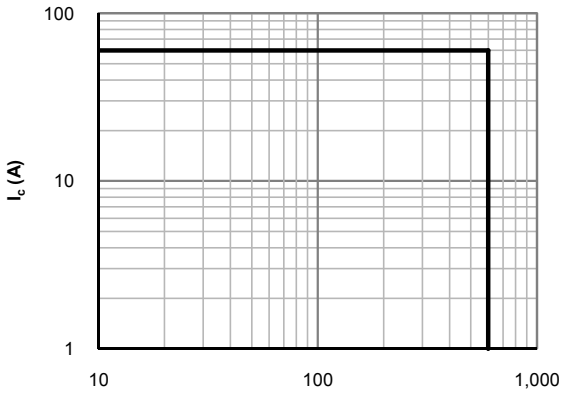


Fig 10: Reverse Bias SOA
(T_j=150°C,V_{GE}=15V)

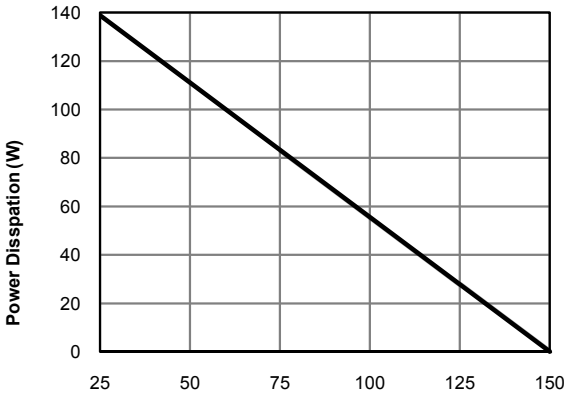


Fig 11: Power Disspation as a Function of Case

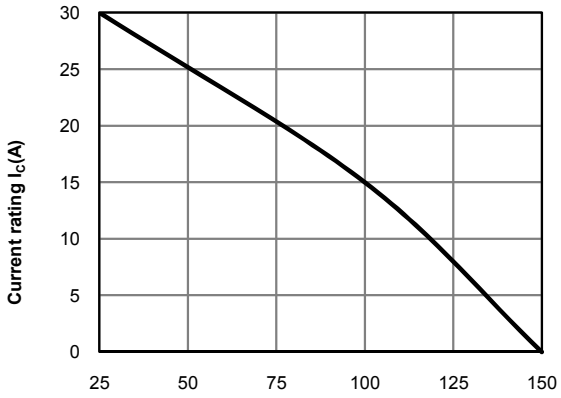


Fig 12: Current De-rating

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

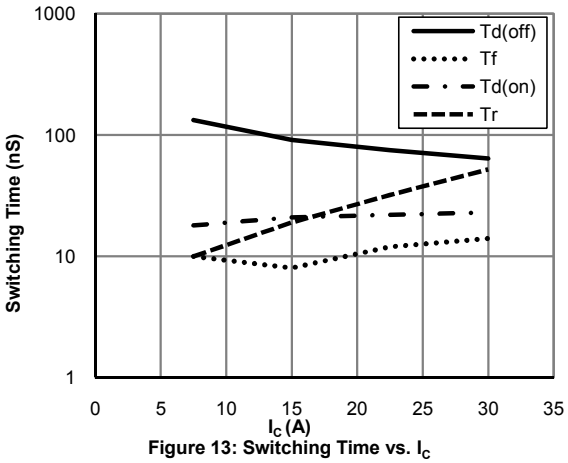


Figure 13: Switching Time vs. I_C
(T_j=150°C,V_{GE}=15V,V_{CE}=400V,R_g=20Ω)

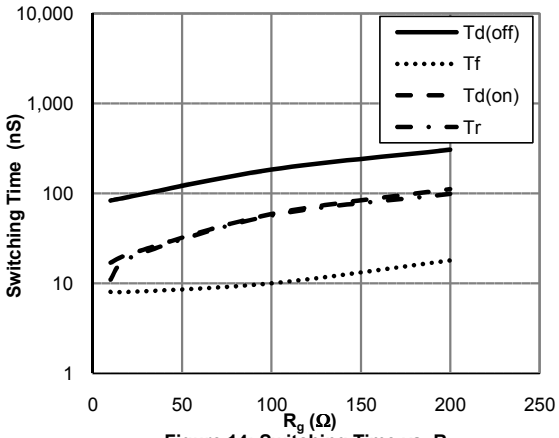


Figure 14: Switching Time vs. R_g
(T_j=150°C,V_{GE}=15V,V_{CE}=400V,I_C=15A)

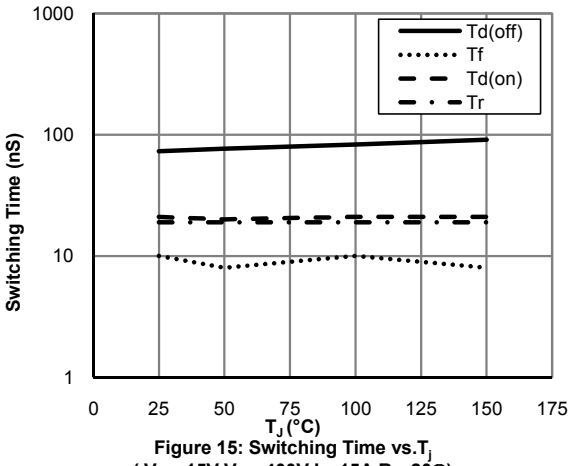


Figure 15: Switching Time vs.T_j
(V_{GE}=15V,V_{CE}=400V,I_C=15A,R_g=20Ω)

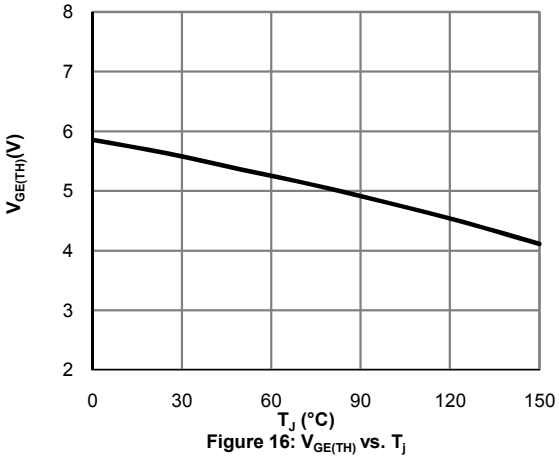


Figure 16: $V_{GE(TH)}$ vs. T_j

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

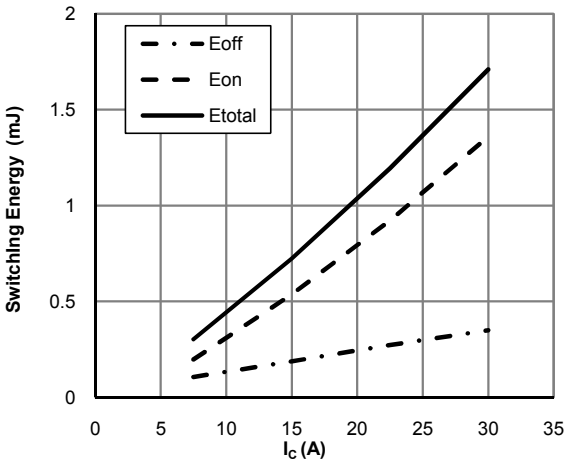


Figure 17: Switching Loss vs. I_C
(T_j=150°C,V_{GE}=15V,V_{CE}=400V,R_g=20Ω)

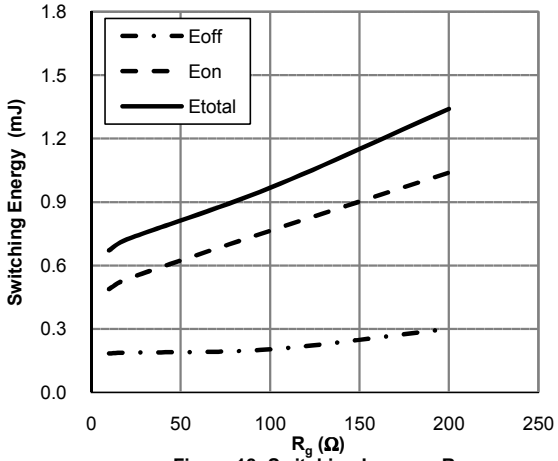


Figure 18: Switching Loss vs. R_g
(T_j=150°C,V_{GE}=15V,V_{CE}=400V,I_C=15A)

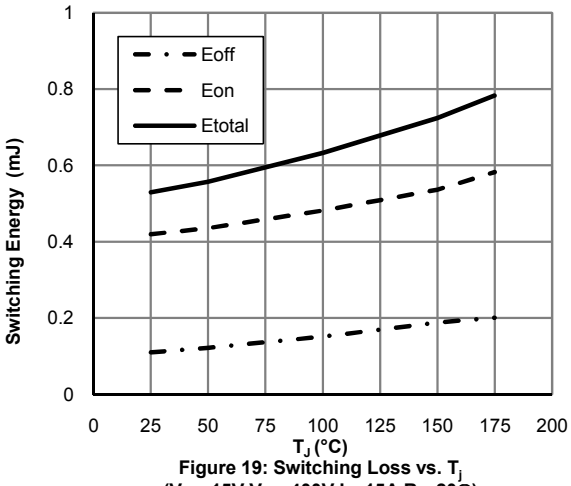


Figure 19: Switching Loss vs. T_j
(V_{GE}=15V,V_{CE}=400V,I_C=15A,R_g=20Ω)

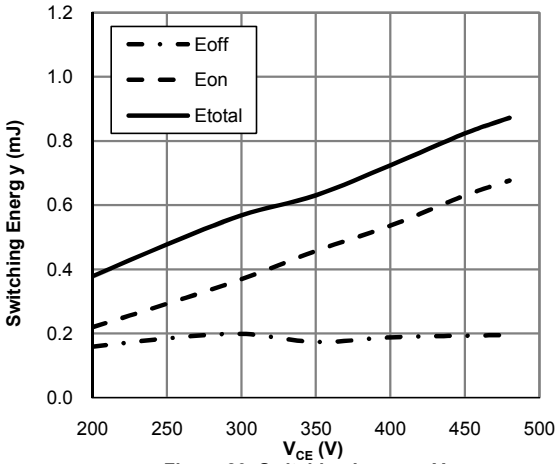


Figure 20: Switching Loss vs. V_{CE}
(T_j=150°C,V_{GE}=15V,I_C=15A,R_g=20Ω)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

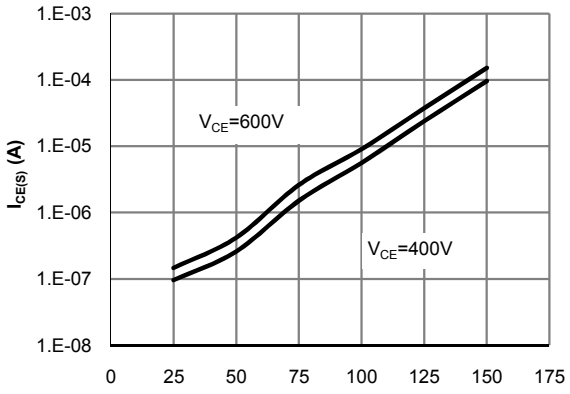


Fig 21: Diode Reverse Leakage Current vs. Junction Temperature

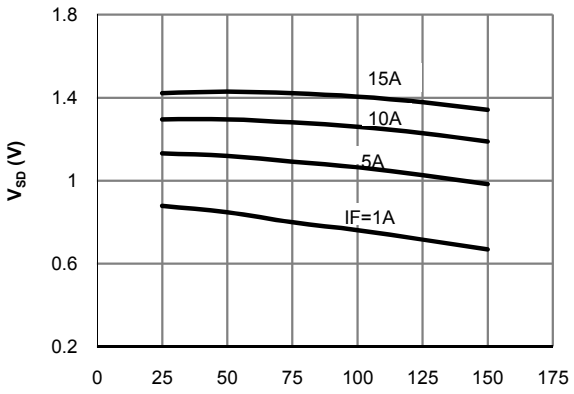


Fig 22: Diode Forward voltage vs. Junction Temperature

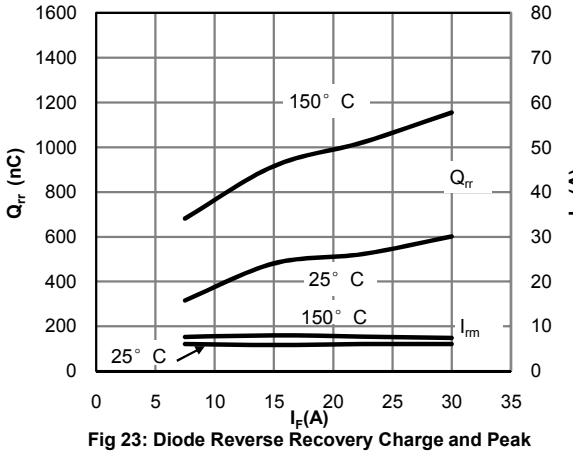


Fig 23: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current (V_{GE}=15V,V_{CE}=400V, di/dt=200A/µs)

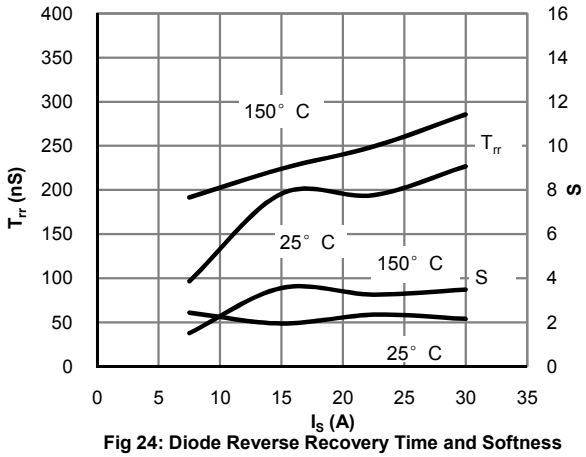


Fig 24: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current (V_{GE}=15V,V_{CE}=400V, di/dt=200A/µs)

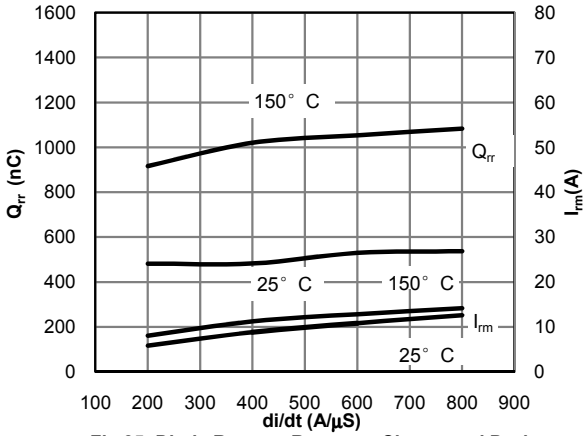


Fig 25: Diode Reverse Recovery Charge and Peak Current vs. di/dt (V_{GE}=15V,V_{CE}=400V,I_F=15A)

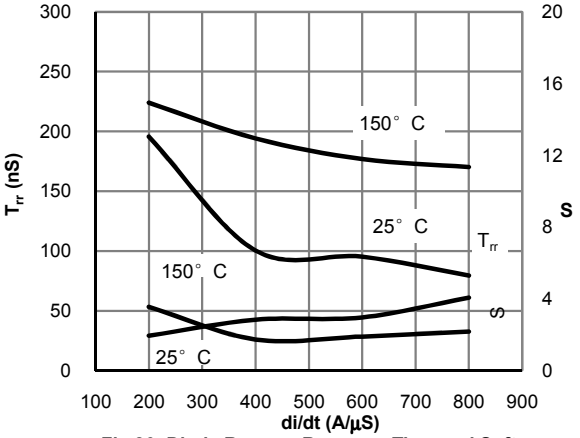


Fig 26: Diode Reverse Recovery Time and Softness Factor vs. di/dt (V_{GE}=15V,V_{CE}=400V,I_F=15A)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

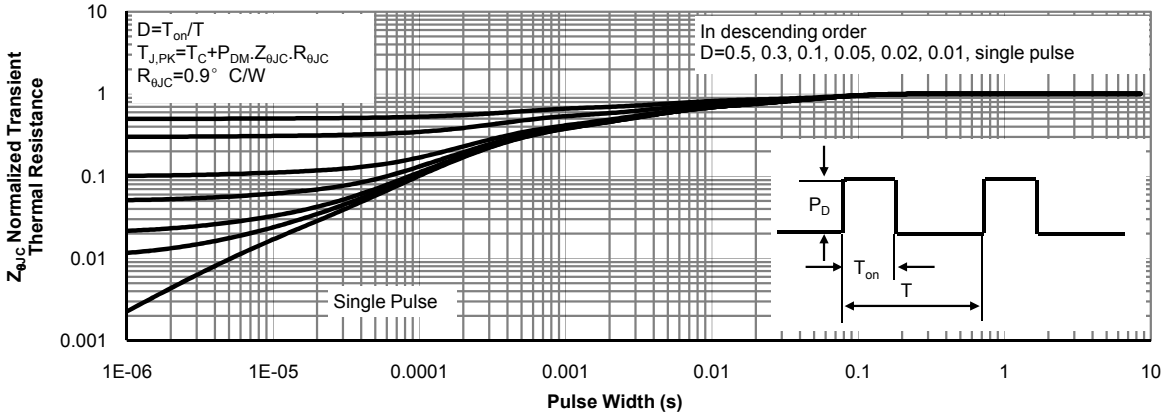


Figure 27: Normalized Maximum Transient Thermal Impedance for IGBT

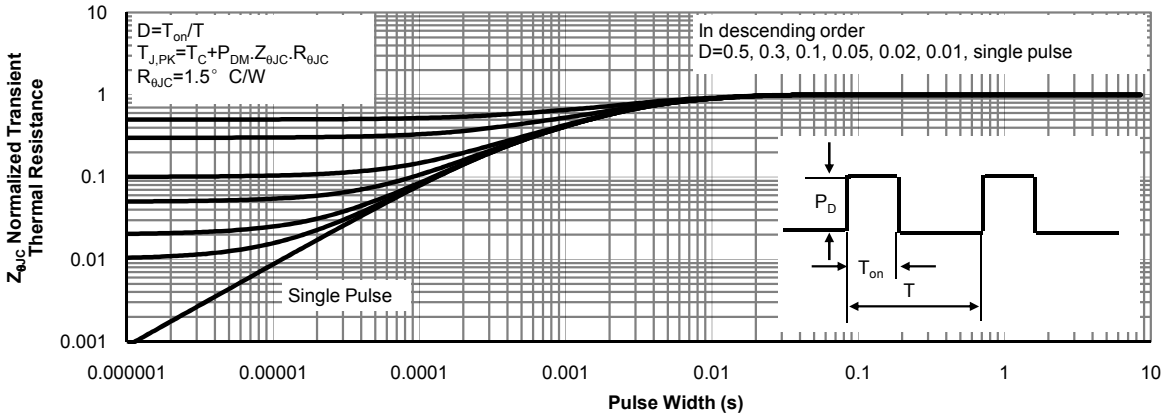
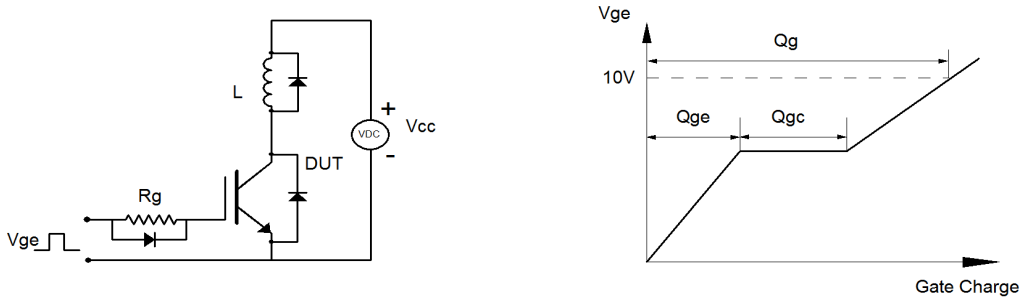
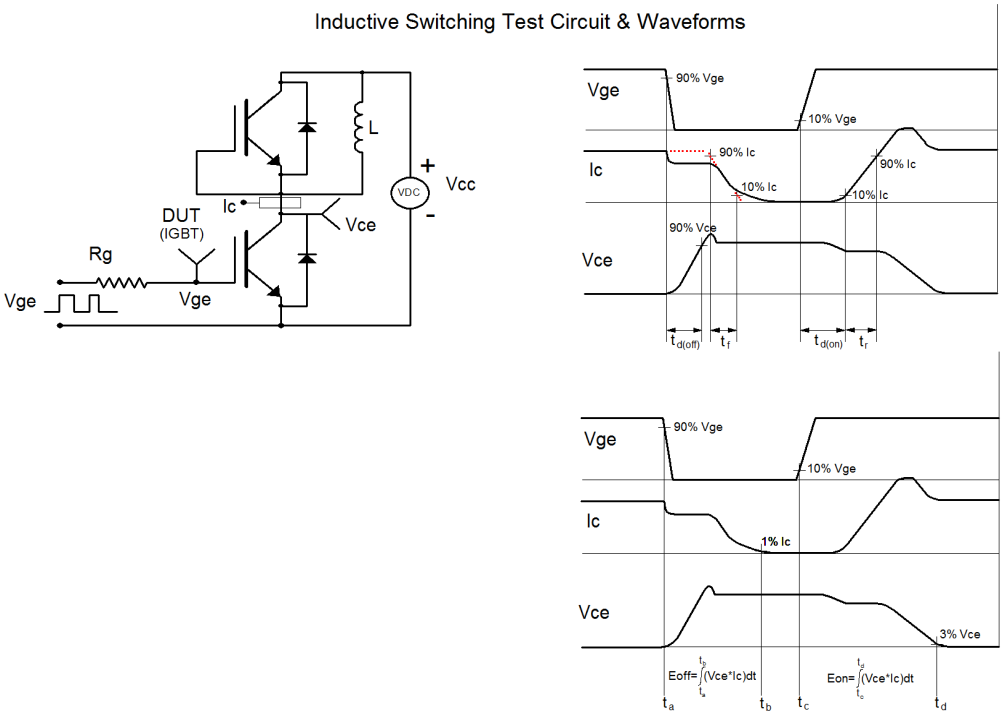


Figure 28: Normalized Maximum Transient Thermal Impedance for Diode

Gate Charge Test Circuit & Waveform



Inductive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms